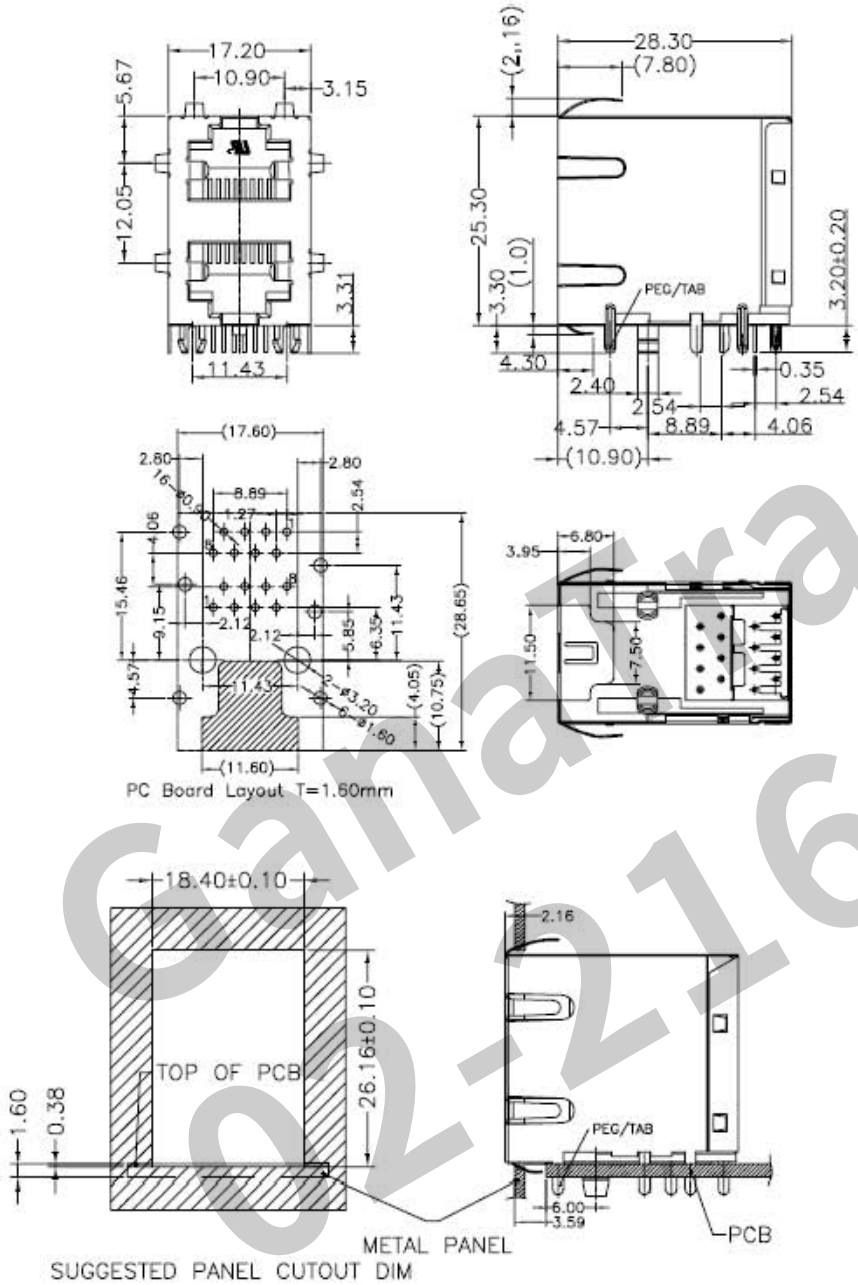
REV 更改	MODIFICATION 說明內容	DATE 日期	DRAW 制圖	APPROVE 核准
A	圖面發行	2012/10/29	JDL	Oscar



NOTES:

MATERIAL:
1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
2.CONTACT MATERIAL :PHOSPHOR BRONZE Ø0.46mm (C5100).
3.PLATING :GOLD PLATING OVER NICKEL.
4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:
1.VOLTAGE RATING :125 VAC RMS.
2.CURRENT RATING :1.5 AMP.
3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:
1.DURRABILITY :750 CYCLES MIN.
2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:
1.STORAGE :-40°C TO +85°C.
2. OPERATION : 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.

QC :Inspection Item
CPK :Cp/Cpk and SPC Control Item

DIMENSION IN mm [Inch]

TOLERANCE UNLESS OTHERWISE SPECIFIED

.X± 0.20	X.°± 1°
.XX± 0.15	.X°± 0.5°
.XXX± 0.075	

APPROVE 核准 | CHECK 審核 | DRAW 制圖: Oscar | PROJ. 投影法 | SCALE 比例: 1:1 | SIZE 圖紙: A3 | SHEET 張數: 1 / 1 | REV 更改: A

HDC 有限公司

FILE NO. 檔案號 | DWG NO. 圖號: GRJJ-H7221

TITLE 名稱: 59A 2X1 8P8C PCB JACK&SHIELDED WITH Backward EMI FINGER,SIDE ENTRY,ROUND PIN

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